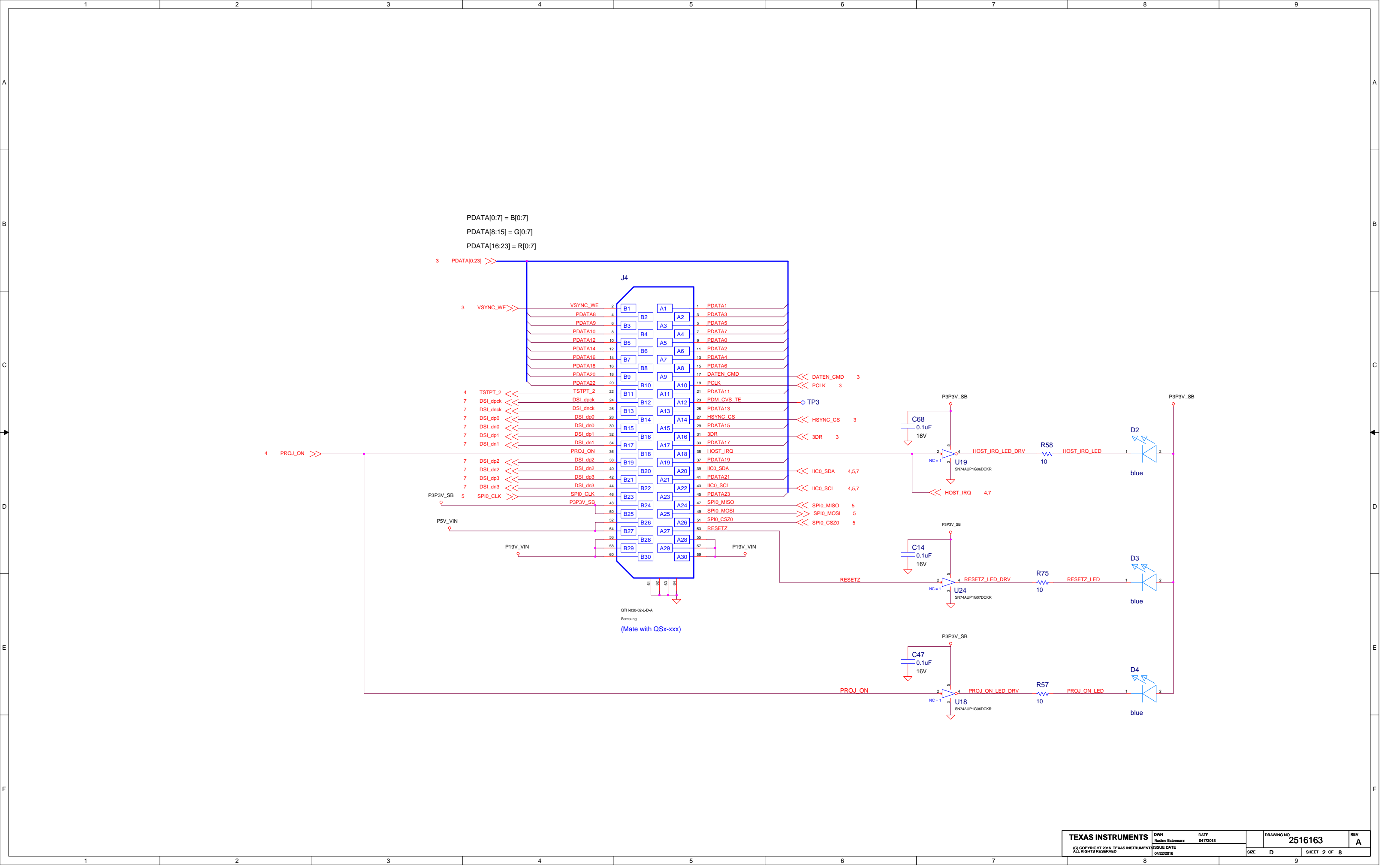
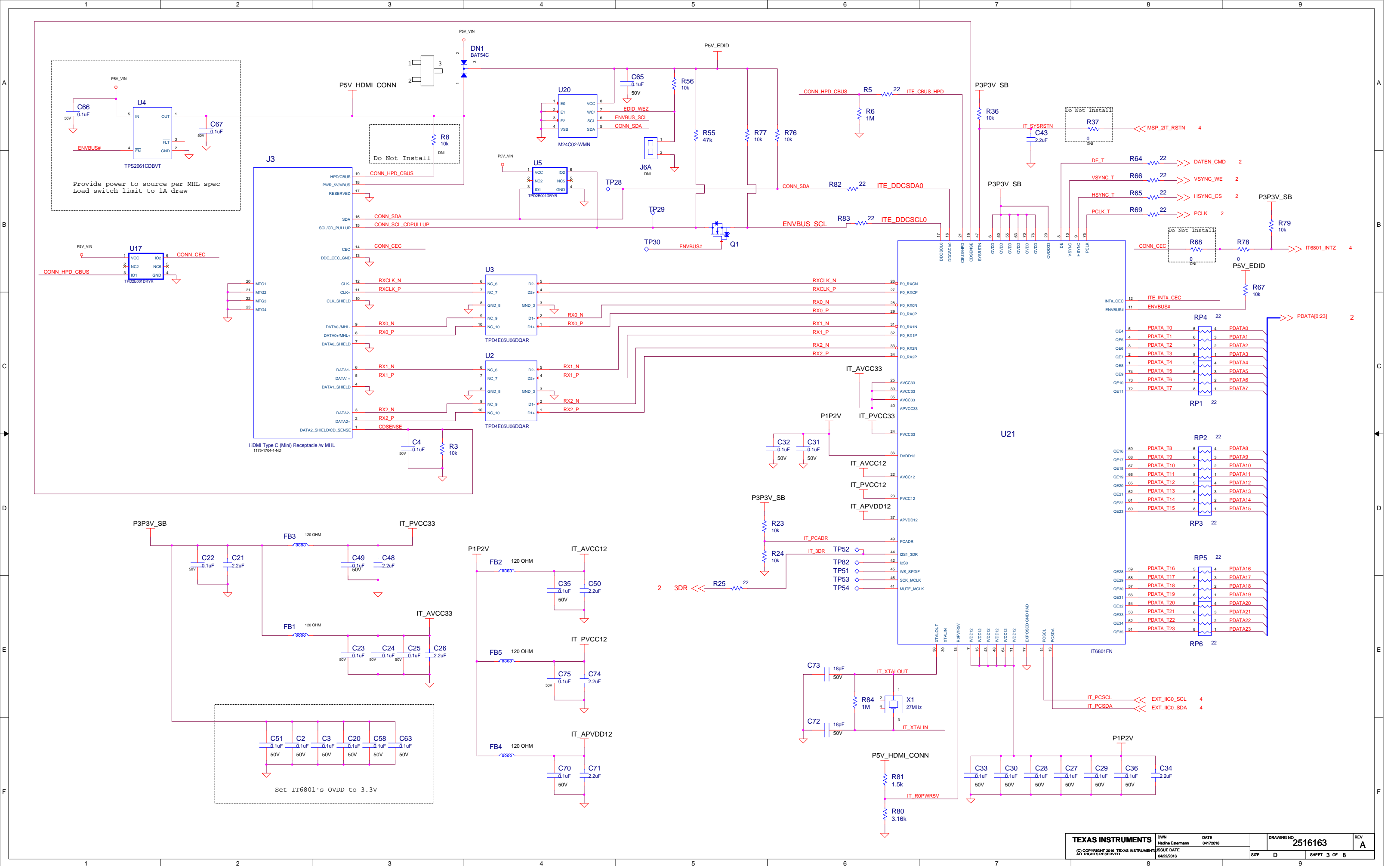


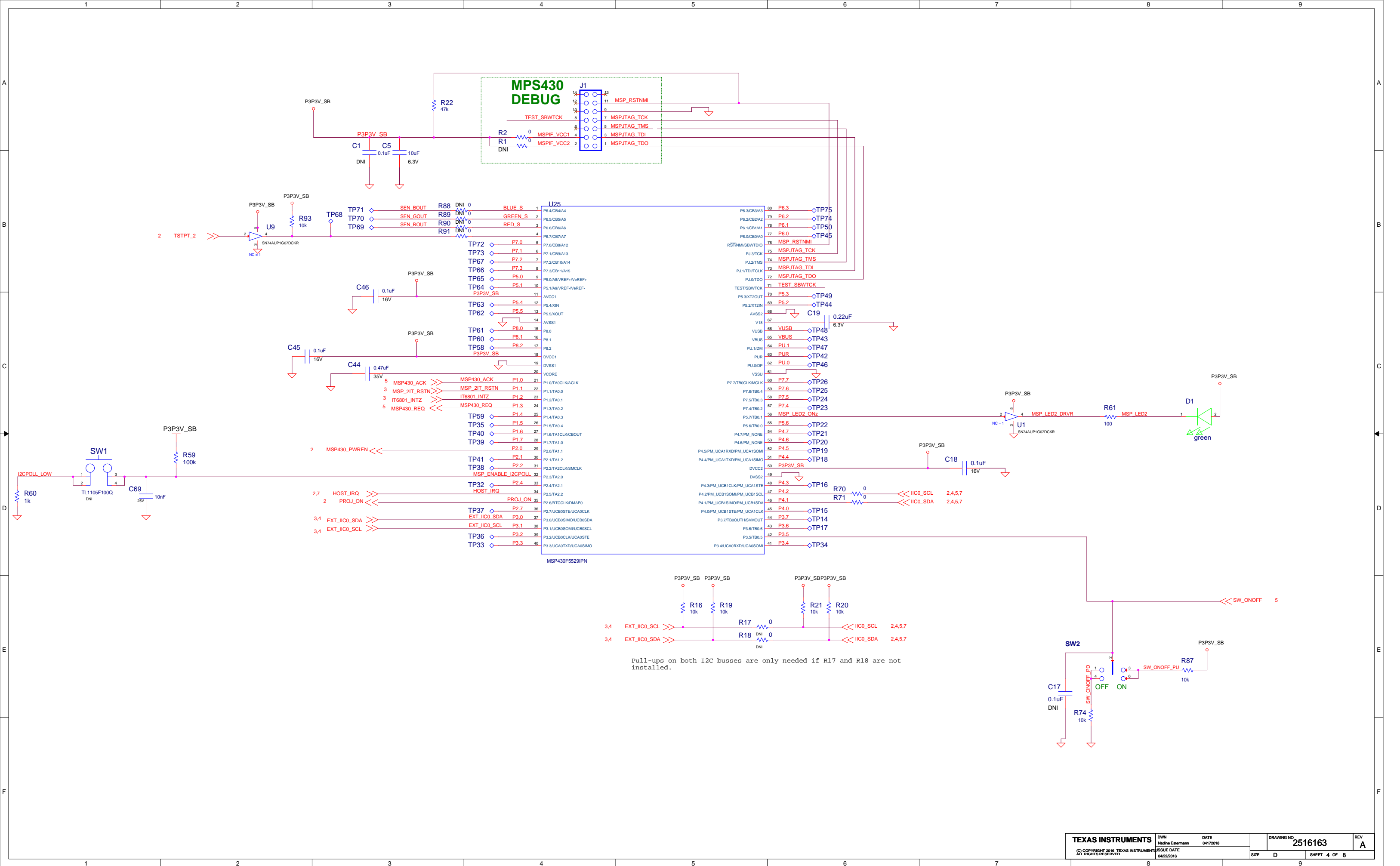
Revision History:
A.0 : Started with DLPDLCR3010EVM-G2 Rev B schematic

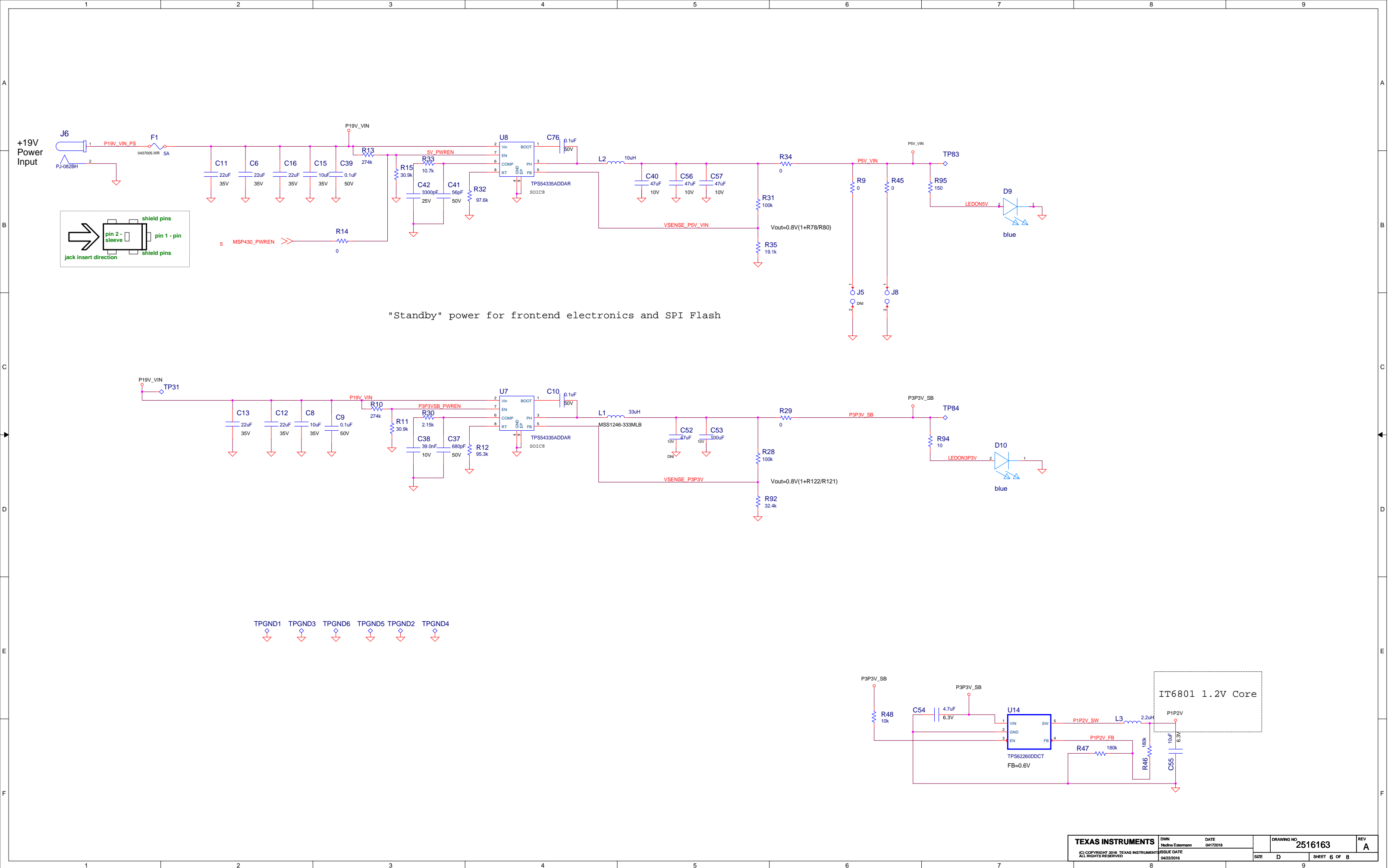
ESD 2516163
PCB 2516164
CCA 2516165

DWN	Nadine Estermann	DATE	04172018	TEXAS INSTRUMENTS - DLP® Products		
ENGR	Nadine Estermann		04172018	(C) COPYRIGHT 2016 Texas Instruments Inc. All Rights Reserved		
SYS	Dan Morgan		---	TITLETIDA-080002 Ultra mobile, low power DLP Pico qHD Main		
APVD	Jeff Dennis		---	DRAWING NO	2516163	REV A
QA	---		---	11 x 17	Orcad Capture 16.6	SHEET 1 of 8

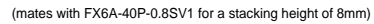








J2



1	2	3	4	5	6	7	8	9												
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							<table><tr><td>TEXAS INSTRUMENTS</td><td>DWN Nedine Estermann</td><td>DATE 04172018</td><td>DRAWING NO. 2516163</td><td>REV A</td></tr><tr><td>(C) COPYRIGHT 2016, TEXAS INSTRUMENTS ALL RIGHTS RESERVED</td><td>ISSUE DATE 04/22/2016</td><td>SIZE D</td><td colspan="2">SHEET 8 OF 8</td></tr></table>		TEXAS INSTRUMENTS	DWN Nedine Estermann	DATE 04172018	DRAWING NO. 2516163	REV A	(C) COPYRIGHT 2016, TEXAS INSTRUMENTS ALL RIGHTS RESERVED	ISSUE DATE 04/22/2016	SIZE D	SHEET 8 OF 8			
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